

A

B

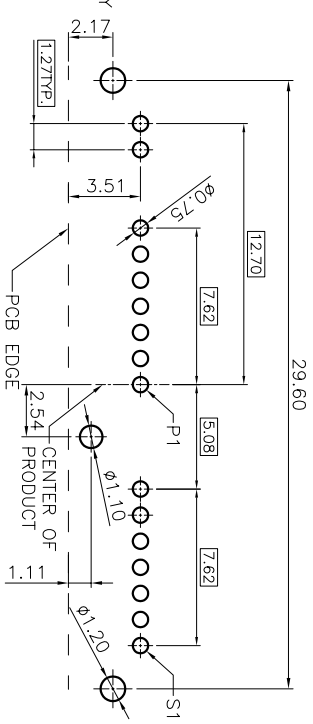
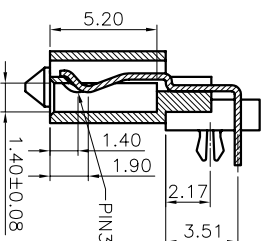
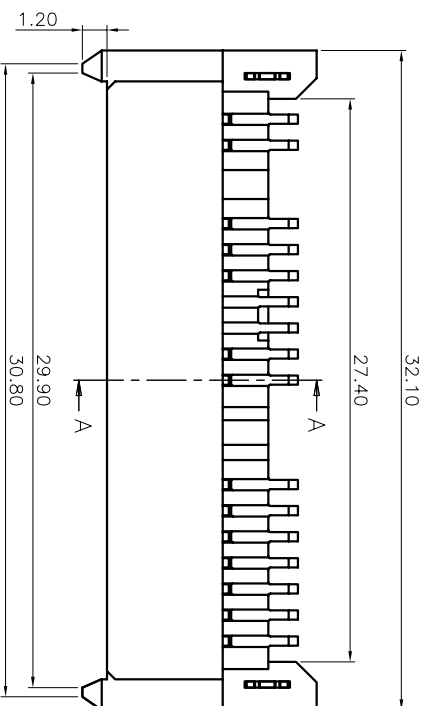
C

D

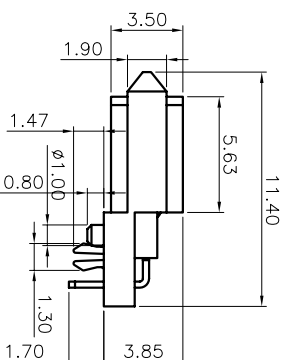
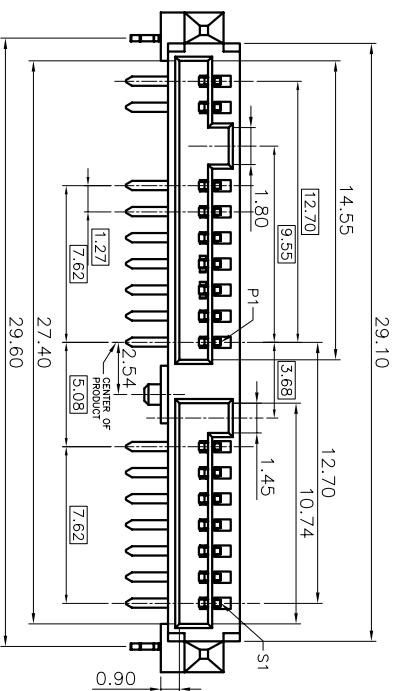
E

CUSTOMER DRAWING

REVISIONS			
SYM	ECN No.	DESCRIPTION	DATE
AX1			03/27/2008
			Jenny



RECOMMENDED PCB LAYOUT
PCB THICKNESS=1.00mm



- NOTE:
- 1.MATERIAL :
BASE : HIGH TEMPERATURE THERMOPLASTIC UL94V-0,
TERMINAL:COPPER ALLOY,THICKNESS = 0.30 mm
FORKLOCK:BRASS THICKNESS = 0.30 mm
 - 2.PLATING:
CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE
SOLDER TAIL:150u"MIN MISTY TIN 50u" MIN NICKEL
UNDERPLATE
GOLD SPECIFICATION:SEE TABLE
 - 3.ELECTRONICAL SPECIFICATION:
CURRENT RATING: 1.5 AMPERE PER CONTACT
CONTACT RESISTANCE: 30 MILLIOHMS MAX.
INSULATION RESISTANCE: 1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC.
OPERATING TEMPERATURE: -40° C~+85° C



PART NUMBER SYSTEM: T5048H44 X 5402N0

Contact Plating

- 1 = G/F
2 = 15u
3 = 30u

TOLERANCE UNIT (mm)	APPROVALS	DATE	TITLE			
X, .40,50	DRAWN ChenTianyu	03/27/2008	USATA 16PIN母頭DIP			
X.X .40,38	CHECKED Johnson	03/27/2008				
X.XX .40,250	APPROVED Johnson	03/27/2008				
X.XXX .40,10	UNIT		SCALE N.A.	PART NO.	DRAWING NO.	REV.
ANGULAR .45°	MM		SHEET 1 OF 1	T5048H44X5402N0	T5048H44X5402N0-AX1	AX1
UNLESS OTHERWISE SPECIFIED			CUSTOMER CODE	CUSTOMER PART NO.		

5

4

3

2

1